

General-purpose Schottky diode in small SOD123F package

Rev. 01 — 25 April 2005 Product data sheet



1.1 General description

General purpose Schottky diode, encapsulated in a SOD123F small and flat lead SMD plastic package.

1.2 Features

- Small and flat lead SMD plastic package
- Flat leads: excellent coplanarity and improved thermal behavior
- Low capacitance
- High switching speed
- Low leakage current

1.3 Applications

- Ultra high-speed switching
- Voltage clamping

1.4 Quick reference data

Table 1: **Quick reference data**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _F	forward current		-	-	120	mA
V _F	forward voltage	I _F = 10 mA	[1] _	-	500	mV
V_R	reverse voltage		-	-	40	V

[1] Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$





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2. Pinning information

Table 2: Pinning

Pin	Description	Simplified outline	Symbol
1	cathode	[1]	
2	anode	1 2	1 - 2
			sym001

^[1] The marking bar indicates the cathode.

3. Ordering information

Table 3: Ordering information

Type number	Package		
	Name	Description	Version
BAS40H	-	plastic surface mounted package; 2 leads	SOD123F

4. Marking

Table 4: Marking codes

Type number	Marking code
BAS40H	AJ

5. Limiting values

Table 5: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

		• •	,		
Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage		-	40	V
I _F	forward current		-	120	mA
I _{FRM}	repetitive peak forward current	$t_p \le 1 \text{ s}; \ \delta \le 0.5$	-	120	mA
I _{FSM}	non-repetitive peak forward current	$t_p \le 10 \text{ ms}$	<u>[1]</u> -	200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2] _	375	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

^[1] $T_j = 25$ °C prior to surge.

^[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

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6. Thermal characteristics

Table 6: Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1][2] _	-	330	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		<u>[3]</u> _	-	70	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

7. Characteristics

Table 7: Characteristics

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	I _F = 1 mA	<u>[1]</u> -	-	380	mV
		$I_F = 10 \text{ mA}$	<u>[1]</u> -	-	500	mV
		$I_F = 40 \text{ mA}$	<u>[1]</u> -	-	1	V
I _R	reverse current	V _R = 30 V	-	-	1	μΑ
		V _R = 40 V	-	-	10	μΑ
C _d	diode capacitance	$V_R = 0 V$; $f = 1 MHz$	-	-	5	pF

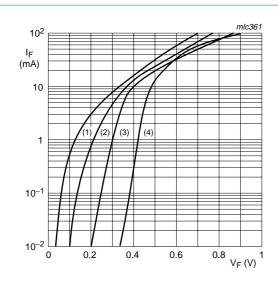
^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

^[2] Reflow soldering is the only recommended soldering method.

^[3] Soldering point of cathode tab.

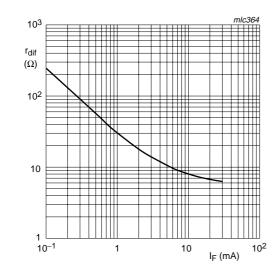


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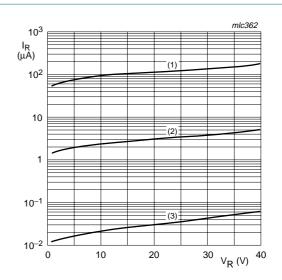
- (1) $T_{amb} = 125 \, ^{\circ}C$
- (2) $T_{amb} = 85 \, ^{\circ}C$
- (3) $T_{amb} = 25 \, ^{\circ}C$
- (4) $T_{amb} = -40 \, ^{\circ}C$

Fig 1. Forward current as a function of forward voltage; typical values



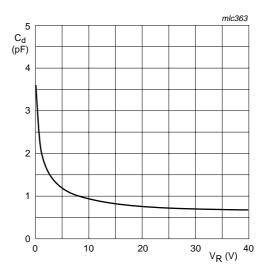
 $T_{amb} = 25 \, ^{\circ}\text{C}; f = 10 \, \text{kHz}$

Fig 3. Differential forward resistance as a function of forward current; typical values



- (1) $T_{amb} = 125 \, ^{\circ}C$
- (2) $T_{amb} = 85 \, ^{\circ}C$
- (3) $T_{amb} = 25 \, ^{\circ}C$

Fig 2. Reverse current as a function of junction temperature



 $T_{amb} = 25 \, ^{\circ}C; f = 1 \, MHz$

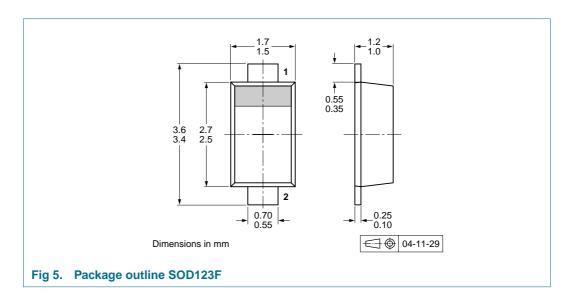
Fig 4. Diode capacitance as a function of reverse voltage; typical values

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8. Package outline



9. Packing information

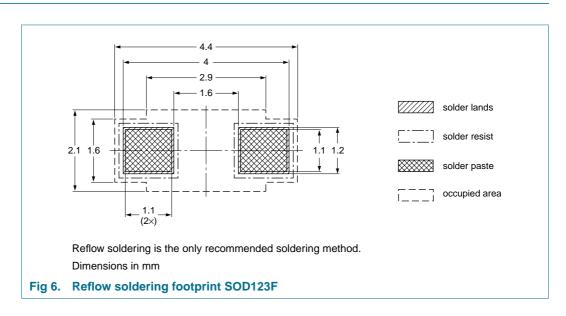
Table 8: Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code. [1]

Type number	Package	Description	Packing qu	uantity
			3000	10000
BAS40H	SOD123F	4 mm pitch, 8 mm tape and reel	-115	-135

^[1] For further information and the availability of packing methods, see $\underline{\text{Section 15}}$.

10. Soldering



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11. Revision history

Table 9: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
BAS40H_1	20050425	Product data sheet	-	9397 750 14968	-

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12. Data sheet status

Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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- [3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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